



THE DATASHEET OF NE5532D8



ON Semiconductor

Is Now

The logo for onsemi, featuring the word "onsemi" in a dark teal, lowercase, sans-serif font. The letter "i" is stylized with a white dot and a teal vertical bar. A small orange triangle is positioned above the top right of the "i". A trademark symbol (TM) is located to the right of the logo.

To learn more about onsemi™, please visit our website at
www.onsemi.com

onsemi and **onsemi** and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi** product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner. Other names and brands may be claimed as the property of others.

NE5532, SA5532, SE5532, NE5532A, SE5532A

Internally Compensated Dual Low Noise Operational Amplifier

The 5532 is a dual high-performance low noise operational amplifier. Compared to most of the standard operational amplifiers, such as the 1458, it shows better noise performance, improved output drive capability and considerably higher small-signal and power bandwidths.

This makes the device especially suitable for application in high-quality and professional audio equipment, instrumentation and control circuits, and telephone channel amplifiers. The op amp is internally compensated for gains equal to one. If very low noise is of prime importance, it is recommended that the 5532A version be used because it has guaranteed noise voltage specifications.

Features

- Small-Signal Bandwidth: 10 MHz
- Output Drive Capability: 600 Ω , 10 V_{RMS}
- Input Noise Voltage: 5.0 nV/ \sqrt{Hz} (Typical)
- DC Voltage Gain: 50000
- AC Voltage Gain: 2200 at 10 kHz
- Power Bandwidth: 140 kHz
- Slew Rate: 9.0 V/ μs
- Large Supply Voltage Range: ± 3.0 to ± 20 V
- Compensated for Unity Gain
- Pb-Free Packages are Available

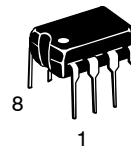


ON Semiconductor®

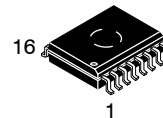
<http://onsemi.com>



SOIC-8
D SUFFIX
CASE 751



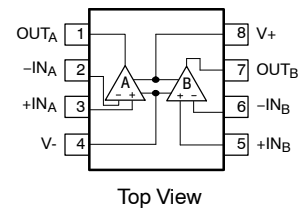
PDIP-8
N SUFFIX
CASE 626



SOIC-16 WB
D SUFFIX
CASE 751G

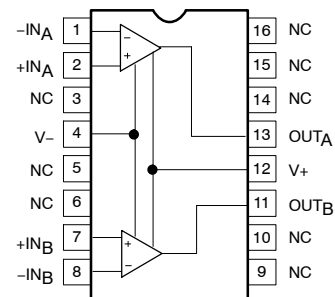
PIN CONNECTIONS

N, D8 Packages



Top View

D Package*



Top View

*SOL and non-standard pinout.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 6 of this data sheet.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

NE5532, SA5532, SE5532, NE5532A, SE5532A

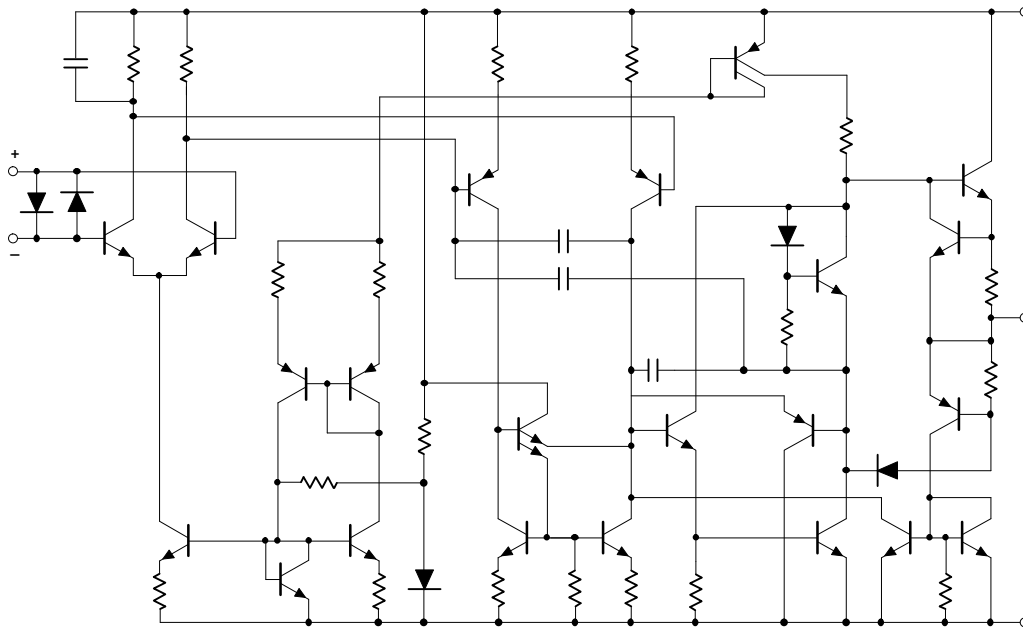


Figure 1. Equivalent Schematic (Each Amplifier)

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|-----------------|--------------------------------------|---------------|
| Supply Voltage | V_S | ± 22 | V |
| Input Voltage | V_{IN} | $\pm V_{SUPPLY}$ | V |
| Differential Input Voltage (Note 1) | V_{DIFF} | ± 0.5 | V |
| Operating Temperature Range NE5532/A SA5532 SE5532/A | T_{amb} | 0 to 70 -40 to +85 -55 to +125 | $^{\circ}C$ |
| Storage Temperature | T_{stg} | -65 to +150 | $^{\circ}C$ |
| Junction Temperature | T_j | 150 | $^{\circ}C$ |
| Maximum Power Dissipation, $T_{amb} = 25^{\circ}C$ (Still-Air) 8 D8 Package 8 N Package 16 D Package | P_D | 780 1200 1200 | mW |
| Thermal Resistance, Junction-to-Ambient 8 D8 Package 8 N Package 16 D Package | $R_{\theta JA}$ | 182 130 140 | $^{\circ}C/W$ |
| Lead Soldering Temperature (10 sec max) | T_{sld} | 230 | $^{\circ}C$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- Diodes protect the inputs against overvoltage. Therefore, unless current-limiting resistors are used, large currents will flow if the differential input voltage exceeds 0.6 V. Maximum current should be limited to ± 10 mA.

NE5532, SA5532, SE5532, NE5532A, SE5532A

DC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$; $V_S = \pm 15\text{ V}$, unless otherwise noted.) (Notes 2, 3 and 4)

| Characteristic | Symbol | Test Conditions | SE5532/A | | | NE5532/A, SA5532 | | | Unit |
|------------------------------|--------------------------|---|----------|------------|------------|------------------|------------|------|--------------------------------|
| | | | Min | Typ | Max | Min | Typ | Max | |
| Offset Voltage | V_{OS} | - | - | 0.5 | 2.0 | - | 0.5 | 4.0 | mV |
| | - | Overtemperature | - | - | 3.0 | - | - | 5.0 | mV |
| | $\Delta V_{OS}/\Delta T$ | - | - | 5.0 | - | - | 5.0 | - | $\mu\text{V}/^{\circ}\text{C}$ |
| Offset Current | I_{OS} | - | - | - | 100 | - | 10 | 150 | nA |
| | - | Overtemperature | - | - | 200 | - | - | 200 | nA |
| | $\Delta I_{OS}/\Delta T$ | - | - | 200 | - | - | 200 | - | $\text{pA}/^{\circ}\text{C}$ |
| Input Current | I_B | - | - | 300 | 500 | - | 300 | 800 | nA |
| | - | Overtemperature | - | - | 700 | - | - | 1000 | nA |
| | $\Delta I_B/\Delta T$ | - | - | 5.0 | - | - | 5.0 | - | $\text{nA}/^{\circ}\text{C}$ |
| Supply Current | I_{CC} | - | - | 8.0 | 10.5 | - | 8.0 | 16 | mA |
| | - | Overtemperature | - | - | 13 | - | - | - | |
| Common-Mode Input Range | V_{CM} | - | ± 12 | ± 13 | - | ± 12 | ± 13 | - | V |
| Common-Mode Rejection Ratio | CMRR | - | 80 | 100 | - | 70 | 100 | - | dB |
| Power Supply Rejection Ratio | PSRR | - | - | 10 | 50 | - | 10 | 100 | $\mu\text{V}/\text{V}$ |
| Large-Signal Voltage Gain | A_{VOL} | $R_L \geq 2.0\text{ k}\Omega$; $V_O = \pm 10\text{ V}$ | 50 | 100 | - | 25 | 100 | - | V/mV |
| | | Overtemperature | 25 | - | - | 15 | - | - | |
| | | $R_L \geq 600\ \Omega$; $V_O = \pm 10\text{ V}$ | 40 | 50 | - | 15 | 50 | - | |
| | | Overtemperature | 20 | - | - | 10 | - | - | |
| Output Swing | V_{OUT} | $R_L \geq 600\ \Omega$ | ± 12 | ± 13 | - | ± 12 | ± 13 | - | V |
| | | Overtemperature | ± 10 | ± 12 | - | ± 10 | ± 12 | - | |
| | | $R_L \geq 600\ \Omega$; $V_S = \pm 18\text{ V}$ | ± 15 | ± 16 | - | ± 15 | ± 16 | - | |
| | | Overtemperature | ± 12 | ± 14 | - | ± 12 | ± 14 | - | |
| | | $R_L \geq 2.0\text{ k}\Omega$ | ± 13 | ± 13.5 | - | ± 13 | ± 13.5 | - | |
| Overtemperature | ± 12 | ± 12.5 | - | ± 10 | ± 12.5 | - | | | |
| Input Resistance | R_{IN} | - | 30 | 300 | - | 30 | 300 | - | $\text{k}\Omega$ |
| Output Short Circuit Current | I_{SC} | - | 10 | 38 | 60 | 10 | 38 | 60 | mA |

2. Diodes protect the inputs against overvoltage. Therefore, unless current-limiting resistors are used, large currents will flow if the differential input voltage exceeds 0.6 V. Maximum current should be limited to $\pm 10\text{ mA}$.
3. For operation at elevated temperature, derate packages based on the package thermal resistance.
4. Output may be shorted to ground at $V_S = \pm 15\text{ V}$, $T_{amb} = 25^{\circ}\text{C}$. Temperature and/or supply voltages must be limited to ensure dissipation rating is not exceeded.

NE5532, SA5532, SE5532, NE5532A, SE5532A

AC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$; $V_S = \pm 15\text{ V}$, unless otherwise noted.)

| Characteristic | Symbol | Test Conditions | NE/SE5532/A, SA5532 | | | Unit |
|------------------------|-----------|---|---------------------|------------|-----|------------------|
| | | | Min | Typ | Max | |
| Output Resistance | R_{OUT} | $A_V = 30\text{ dB}$ Closed-loop $f = 10\text{ kHz}$, $R_L = 600\ \Omega$ | – | 0.3 | – | Ω |
| Overshoot | – | Voltage-Follower $V_{IN} = 100\text{ mV}_{P-P}$ $C_L = 100\text{ pF}$; $R_L = 600\ \Omega$ | – | 10 | – | % |
| Gain | A_V | $f = 10\text{ kHz}$ | – | 2.2 | – | V/mV |
| Gain Bandwidth Product | GBW | $C_L = 100\text{ pF}$; $R_L = 600\ \Omega$ | – | 10 | – | MHz |
| Slew Rate | SR | – | – | 9.0 | – | V/ μs |
| Power Bandwidth | – | $V_{OUT} = \pm 10\text{ V}$ $V_{OUT} = \pm 14\text{ V}$; $R_L = 600\ \Omega$ $V_{CC} = \pm 18\text{ V}$ | – | 140 100 | – | kHz |

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$; $V_S = \pm 15\text{ V}$, unless otherwise noted.)

| Characteristic | Symbol | Test Conditions | NE/SE5532 | | | NE/SA/SE5532A | | | Unit |
|---------------------|-------------|---|-----------|-----|-----|---------------|-----|-----|------------------------|
| | | | Min | Typ | Max | Min | Typ | Max | |
| Input Noise Voltage | V_{NOISE} | $f_O = 30\text{ Hz}$ | – | 8.0 | – | – | 8.0 | 12 | nV/ $\sqrt{\text{Hz}}$ |
| | | $f_O = 1.0\text{ kHz}$ | – | 5.0 | – | – | 5.0 | 6.0 | |
| Input Noise Current | I_{NOISE} | $f_O = 30\text{ Hz}$ | – | 2.7 | – | – | 2.7 | – | pA/ $\sqrt{\text{Hz}}$ |
| | | $f_O = 1.0\text{ kHz}$ | – | 0.7 | – | – | 0.7 | – | |
| Channel Separation | – | $f = 1.0\text{ kHz}$; $R_S = 5.0\text{ k}\Omega$ | – | 110 | – | – | 110 | – | dB |

TYPICAL PERFORMANCE CHARACTERISTICS

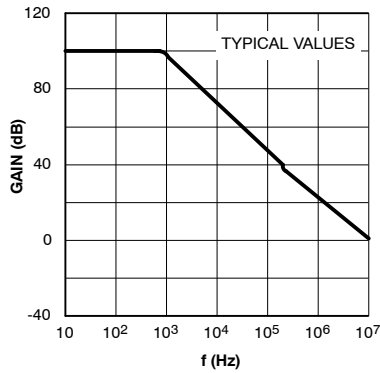


Figure 2. Open-Loop Frequency Response

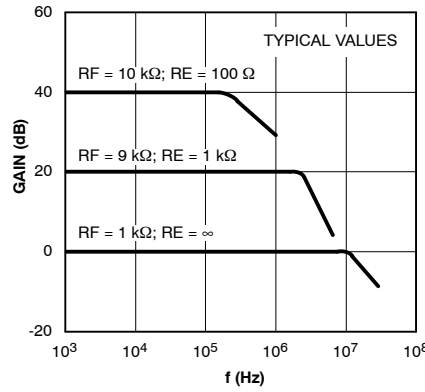


Figure 3. Closed-Loop Frequency Response

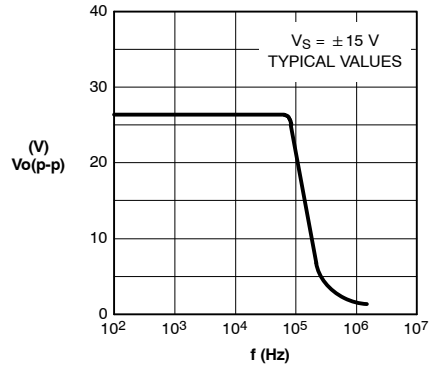


Figure 4. Large-Signal Frequency Response

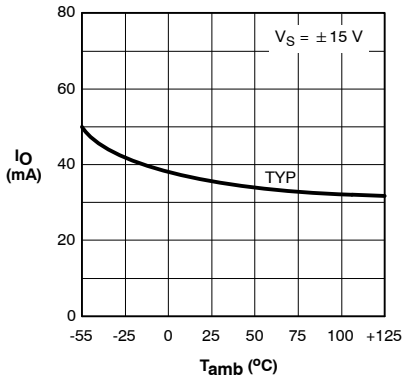


Figure 5. Output Short-Circuit Current

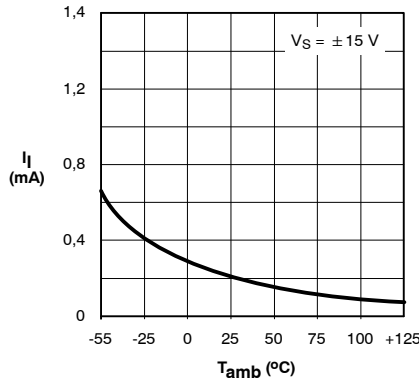


Figure 6. Input Bias Current

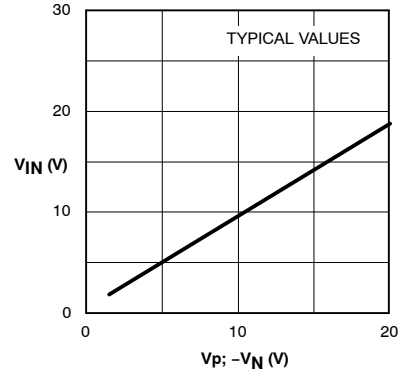


Figure 7. Input Common-Mode Voltage Range

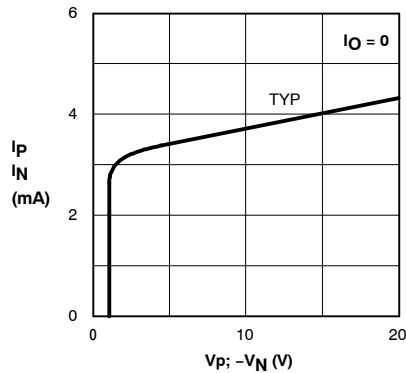


Figure 8. Supply Current

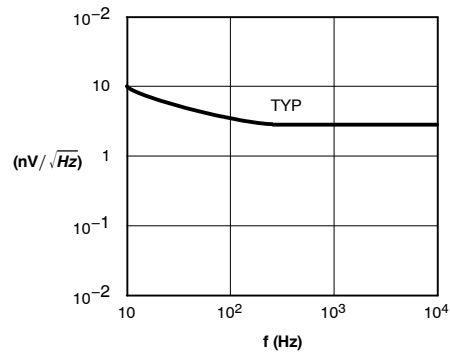
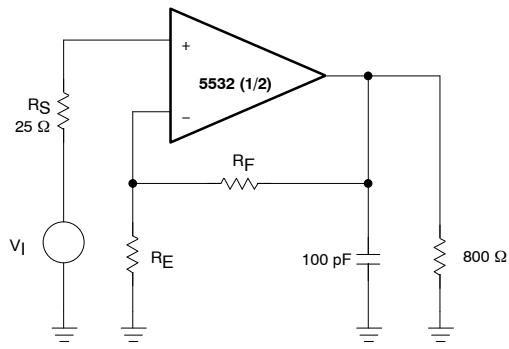
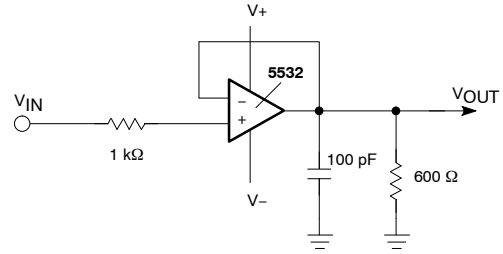


Figure 9. Input Noise Voltage Density

NE5532, SA5532, SE5532, NE5532A, SE5532A



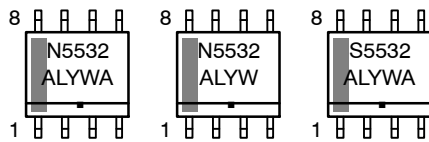
Closed-Loop Frequency Response



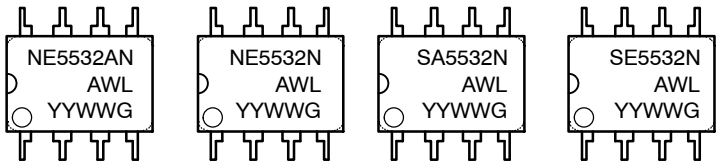
Voltage-Follower

Figure 10. Test Circuits

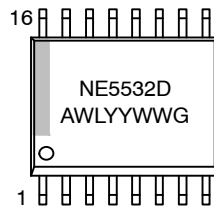
MARKING DIAGRAMS



**SOIC-8
D SUFFIX
CASE 751**



**PDIP-8
N SUFFIX
CASE 626**



**SOIC-16 WB
D SUFFIX
CASE 751G**

- A = Assembly Location
- WL, L = Wafer Lot
- YY, Y = Year
- WW, W = Work Week
- G or ■ = Pb-Free Package

NE5532, SA5532, SE5532, NE5532A, SE5532A

ORDERING INFORMATION

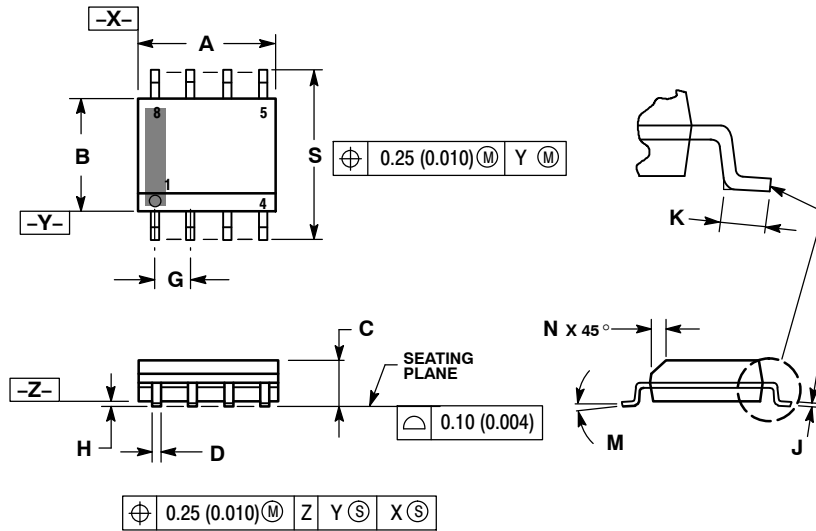
| Device | Description | Temperature Range | Shipping† | |
|--------------|---|-------------------|--------------------|-----------------|
| NE5532AD8 | 8-Pin Plastic Small Outline (SO-8) Package | 0 to 70°C | 98 Units / Rail | |
| NE5532AD8G | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | | 98 Units / Rail | |
| NE5532AD8R2 | 8-Pin Plastic Small Outline (SO-8) Package | | 2500 / Tape & Reel | |
| NE5532AD8R2G | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | | 2500 / Tape & Reel | |
| NE5532AN | 8-Pin Plastic Dual In-Line Package (PDIP-8) | | 50 Units / Rail | |
| NE5532ANG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | | 50 Units / Rail | |
| NE5532D | 16-Pin Plastic Small Outline (SO-16 WB) Package | | 47 Units / Rail | |
| NE5532DG | 16-Pin Plastic Small Outline (SO-16 WB) Package (Pb-Free) | | 47 Units / Rail | |
| NE5532DR2 | 16-Pin Plastic Small Outline (SO-16 WB) Package | | 1000 Tape & Reel | |
| NE5532DR2G | 16-Pin Plastic Small Outline (SO-16 WB) Package (Pb-Free) | | 1000 Tape & Reel | |
| NE5532D8 | 8-Pin Plastic Small Outline (SO-8) Package | | 98 Units / Rail | |
| NE5532D8G | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | | 98 Units / Rail | |
| NE5532D8R2 | 8-Pin Plastic Small Outline (SO-8) Package | | 2500 / Tape & Reel | |
| NE5532D8R2G | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | | 2500 / Tape & Reel | |
| NE5532N | 8-Pin Plastic Dual In-Line Package (PDIP-8) | | 50 Units / Rail | |
| NE5532NG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | | 50 Units / Rail | |
| SA5532N | 8-Pin Plastic Dual In-Line Package (PDIP-8) | | -40 to +85°C | 50 Units / Rail |
| SA5532NG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | | | 50 Units / Rail |
| SE5532AD8 | 8-Pin Plastic Small Outline (SO-8) Package | -55 to +125°C | 98 Units / Rail | |
| SE5532AD8G | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | | 98 Units / Rail | |
| SE5532AD8R2 | 8-Pin Plastic Small Outline (SO-8) Package | | 2500 / Tape & Reel | |
| SE5532AD8R2G | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | | 2500 / Tape & Reel | |
| SE5532N | 8-Pin Plastic Dual In-Line Package (PDIP-8) | | 50 Units / Rail | |
| SE5532NG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | | 50 Units / Rail | |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NE5532, SA5532, SE5532, NE5532A, SE5532A

PACKAGE DIMENSIONS

SOIC-8 NB
CASE 751-07
ISSUE AK

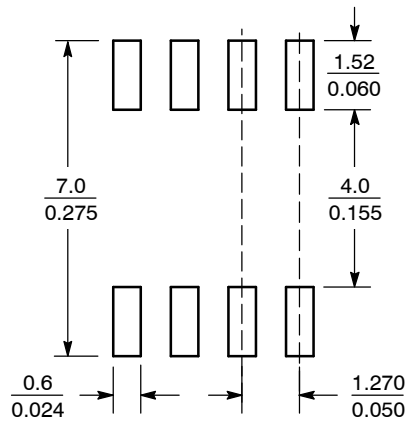


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.80 | 5.00 | 0.189 | 0.197 |
| B | 3.80 | 4.00 | 0.150 | 0.157 |
| C | 1.35 | 1.75 | 0.053 | 0.069 |
| D | 0.33 | 0.51 | 0.013 | 0.020 |
| G | 1.27 BSC | | 0.050 BSC | |
| H | 0.10 | 0.25 | 0.004 | 0.010 |
| J | 0.19 | 0.25 | 0.007 | 0.010 |
| K | 0.40 | 1.27 | 0.016 | 0.050 |
| M | 0° | 8° | 0° | 8° |
| N | 0.25 | 0.50 | 0.010 | 0.020 |
| S | 5.80 | 6.20 | 0.228 | 0.244 |

SOLDERING FOOTPRINT*



SCALE 6:1 $\left(\frac{\text{mm}}{\text{inches}}\right)$

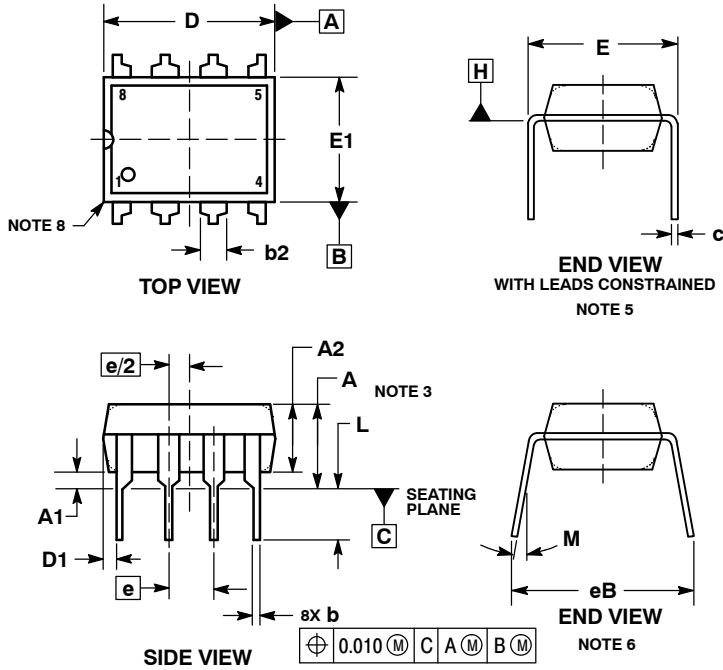
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NE5532, SA5532, SE5532, NE5532A, SE5532A

PACKAGE DIMENSIONS

8-Pin Plastic Dual In-Line Package (PDIP-8)

N SUFFIX
CASE 626-05
ISSUE N



NOTES:

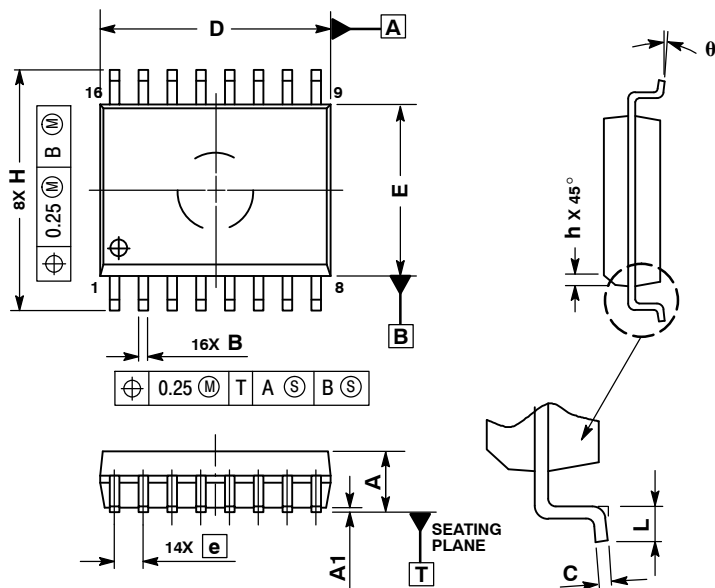
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.
4. DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
5. DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
6. DIMENSION E3 IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
7. DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | ---- | 0.210 | ---- | 5.33 |
| A1 | 0.015 | ---- | 0.38 | ---- |
| A2 | 0.115 | 0.195 | 2.92 | 4.95 |
| b | 0.014 | 0.022 | 0.35 | 0.56 |
| b2 | 0.060 TYP | | 1.52 TYP | |
| C | 0.008 | 0.014 | 0.20 | 0.36 |
| D | 0.355 | 0.400 | 9.02 | 10.16 |
| D1 | 0.005 | ---- | 0.13 | ---- |
| E | 0.300 | 0.325 | 7.62 | 8.26 |
| E1 | 0.240 | 0.280 | 6.10 | 7.11 |
| e | 0.100 BSC | | 2.54 BSC | |
| eB | ---- | 0.430 | ---- | 10.92 |
| L | 0.115 | 0.150 | 2.92 | 3.81 |
| M | ---- | 10° | ---- | 10° |

NE5532, SA5532, SE5532, NE5532A, SE5532A

PACKAGE DIMENSIONS

SOIC-16 WB
D SUFFIX
CASE 751G-03
ISSUE D

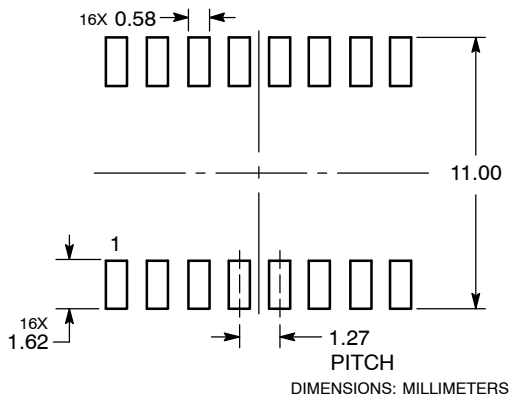


NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS | |
|-----|-------------|-------|
| | MIN | MAX |
| A | 2.35 | 2.65 |
| A1 | 0.10 | 0.25 |
| B | 0.35 | 0.49 |
| C | 0.23 | 0.32 |
| D | 10.15 | 10.45 |
| E | 7.40 | 7.60 |
| e | 1.27 BSC | |
| H | 10.05 | 10.55 |
| h | 0.25 | 0.75 |
| L | 0.50 | 0.90 |
| q | 0° | 7° |

SOLDERING FOOTPRINT



ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

 [View NE5532D8 on WIN SOURCE](#)

 [ON Semiconductor](#) Information

Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management